<u>S/N 10/789,882</u> <u>PATENT</u>

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Paul A. Farrar

Examiner: Dao H Nguyen

Serial No.:

10/789,882

Group Art Unit: 2818

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Title:

INTEGRATED CIRCUIT AND SEED LAYERS

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

This responds to the Office Action mailed on <u>February 7, 2007</u>. Please amend the above-identified patent application as follows.